

## N-Channel Enhancement-Mode MOSFET

Designed for handheld two-way radio applications with frequencies from 136 to 941 MHz. The high gain, ruggedness and Broadband performance of this device make it ideal for large-signal, common-source amplifier applications in handheld radio equipment.

**136–941 MHz, 1.0W, 3.7  
V BROADBAND RF  
POWER TRANSISTOR**

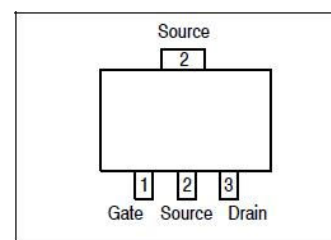
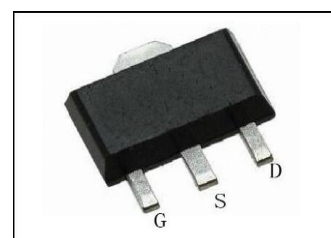
### Typical Broadband EVB Performance ( $I_{DQ}=200\text{mA}$ , $T_A = 25^\circ\text{C}$ , CW)

| VDD | Freq. | Pout  |         | Gmax |
|-----|-------|-------|---------|------|
| [V] | [MHz] | [dBm] | [Watts] | [dB] |
| 3.7 | 400   | 31.2  | 1.3     | 18.9 |
|     | 440   | 31.1  | 1.3     | 19.1 |
|     | 460   | 31.1  | 1.3     | 18.5 |
|     | 480   | 31.0  | 1.3     | 18.2 |

### Typical Narrowband EVB Performance ( $I_{DQ}=200\text{mA}$ , $T_A = 25^\circ\text{C}$ , CW)

| VDD | Freq. | Pout  |         | PAE  |
|-----|-------|-------|---------|------|
| [V] | [MHz] | [dBm] | [Watts] | [%]  |
| 3.7 | 430   | 32.1  | 1.6     | 53.4 |
|     | 450   | 32.7  | 1.8     | 57.2 |
|     | 470   | 32.6  | 1.8     | 62.3 |

Capable of Handling 20:1 VSWR@6.0Vdc, 2.0Watts, CW



**Figure 1. Pin Connections**

## Features

- Characterized for Operation from 136 to 941 MHz
- Unmatched Input and Output Allowing Broad Frequency Range Utilization
- Integrated ESD Protection
- Broadband – Full Power Across the Band
- Exceptional Thermal Performance
- Extreme Ruggedness

## Typical Applications

- Output Stage VHF Band Handheld Radio
- Output Stage UHF Band Handheld Radio
- Output Stage for 700–800 MHz Handheld Radio
- Driver for 10–1000 MHz Applications

# HPL09S001N

## RF Power Field Effect Transistor

**Table1. Maximum Ratings**

| Rating                         | Symbol    | Value       | Unit |
|--------------------------------|-----------|-------------|------|
| Drain-Source Voltage           | $V_{DSS}$ | -0.5, +20   | Vdc  |
| Gate-Source Voltage            | $V_{GS}$  | -5.0, +8    | Vdc  |
| Operating Voltage              | $V_{DD}$  | 0, +6       | Vdc  |
| Storage Temperature Range      | $T_{stg}$ | -65 to +150 | °C   |
| Case Operating Temperature     | $T_C$     | -40 to +150 | °C   |
| Operating Junction Temperature | $T_J$     | -40 to +150 | °C   |
| Power Dissipation @TC=25 °C    | PD        | 5           | W    |

**Table2. ESD Protection Characteristic**

| Test Methodology                       | Class             |
|--|-------------------|
| Human Body Model (per JESD22--A114)    | 2, passes 2500 V  |
| Machine Model (per EIA/JESD22--A115)   | A, passes 100 V   |
| Charge Device Model (per JESD22--C101) | IV, passes 2000 V |

**Table3. Electrical Characteristics** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

| Characteristic | Symbol | Min | Typ. | Max | Unit |
|----------------|--------|-----|------|-----|------|
|----------------|--------|-----|------|-----|------|

### Off Characteristics

|  |           |   |   |   |                 |
|--|-----------|---|---|---|-----------------|
| Gate-Source Leakage Current<br>( $V_{GS}=5\text{Vdc}$ , $V_{DS}=0\text{Vdc}$ )               | $I_{GSS}$ | - | - | 1 | $\mu\text{Adc}$ |
| Zero Gate Voltage Drain Leakage Current<br>( $V_{DS}=16\text{Vdc}$ , $V_{GS}=0\text{Vdc}$ )  | $I_{DSS}$ | - | - | 2 | $\mu\text{Adc}$ |
| Zero Gate Voltage Drain Leakage Current<br>( $V_{DS}=3.7\text{Vdc}$ , $V_{GS}=0\text{Vdc}$ ) | $I_{DSS}$ | - | - | 1 | $\mu\text{Adc}$ |

### On Characteristics

|  |              |     |      |     |     |
|--|--------------|-----|------|-----|-----|
| Gate Threshold Voltage ( $V_{DS}=3.7\text{Vdc}$ , $I_D=1\text{mA}$ )                                 | $V_{GS(th)}$ | 1.2 | 1.5  | 1.8 | Vdc |
| Gate Quiescent Voltage ( $V_{DD}=3.7\text{Vdc}$ , $I_D=200\text{mA}$<br>Measured in Functional Test) | $V_{GS(Q)}$  | 1.3 | 2.0  | 2.7 | Vdc |
| Drain-Source On-Voltage ( $V_{GS}=5\text{Vdc}$ , $I_D=200\text{mA}$ )                                | $V_{DS(ON)}$ | -   | 0.09 | -   | Vdc |

### Dynamic Characteristics

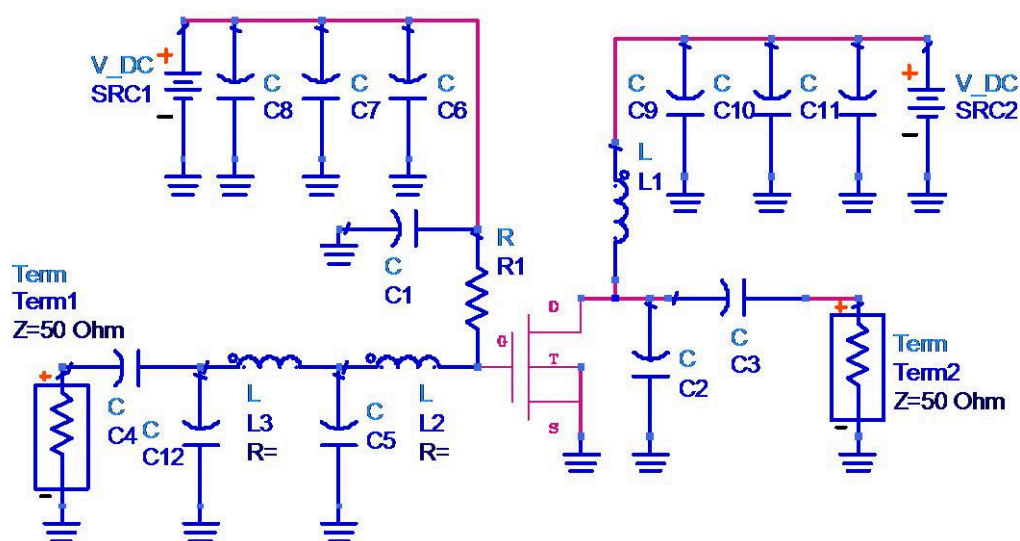
|   |           |   |      |   |    |
|---|-----------|---|------|---|----|
| Reverse Transfer Capacitance<br>( $V_{DG}=3.7\text{V}$ , Level=30mVac@1MHz) | $C_{rss}$ | - | 2.4  | - | pF |
| Output Capacitance<br>( $V_{DS}=3.7\text{V}$ , Level=30mVac@1MHz)           | $C_{oss}$ | - | 9.1  | - | pF |
| Input Capacitance<br>( $V_{GS}=5\text{V}$ , Level=30mVac@1MHz)              | $C_{iss}$ | - | 32.0 | - | pF |

### Typical Performances

 (In DuSemi Narrowband Test DEMO, 50 Ohm system)

Frequency=450MHz,  $V_{DS}=3.7\text{Vdc}$ ,  $I_{DQ}=200\text{mA}$ ,  $T_A=25^\circ\text{C}$

|                  |           |   |    |   |     |
|------------------|-----------|---|----|---|-----|
| Power Gain       | $G_{PS}$  | - | 19 | - | dB  |
| Output Power     | $P_{out}$ | - | 31 | - | dBm |
| Drain Efficiency | $\eta_p$  | - | 60 | - | %   |

**Broad Band Evaluation Circuit (@VDD = 3.7V, f = 440 MHz)**

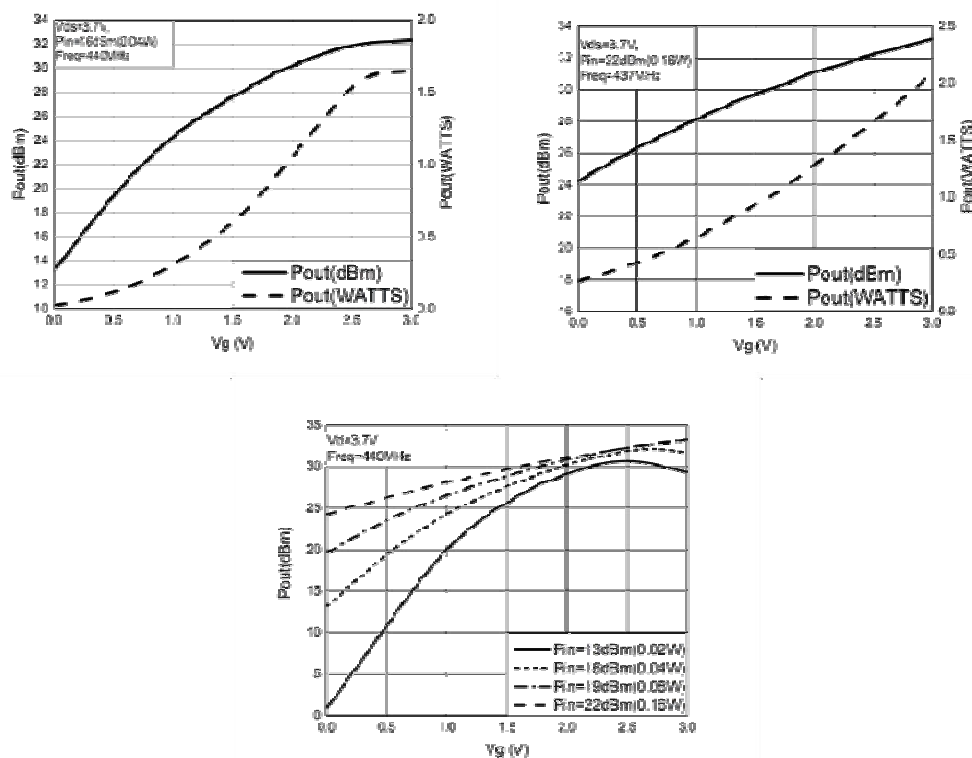
Test Circuit Component Layout

**Table4. Test Circuit Component Designations and Value**

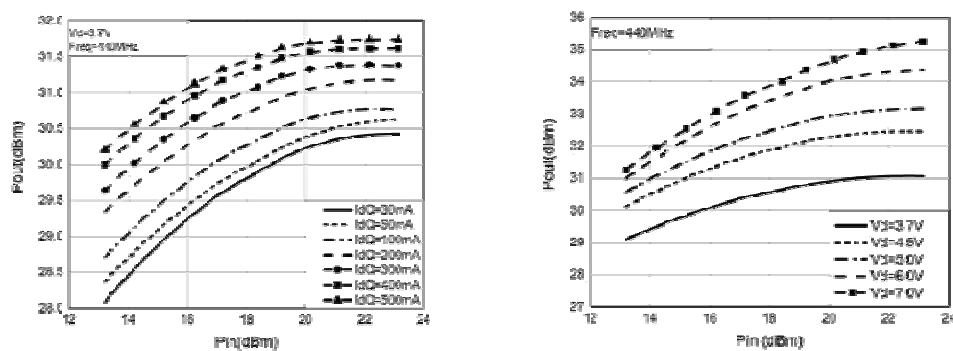
| Part            | Description                                | Part Number       | Manufacturer |
|-----------------|--|-------------------|--------------|
| R1              | 1KOhm                                      | —                 | —            |
| L2,L3           | 1nH  | —                 | —            |
| L1              | 8 Turns D: 0.5 mm,<br>φ 2.4 mm Enamel Wire | —                 | —            |
| C1, C3,C4,C6,C9 | 100pF Chip Capacitors                      | GQM21P5C1H101JB01 | Murata       |
| C2, C5          | 10pF Chip Capacitors                       | GRM1885C1H201JA01 | Murata       |
| C7,C10          | 1000pF Chip Capacitors                     | GRM1885C1H102JA01 | Murata       |
| C8,C11          | 10uF,10VChip Capacitors                    | —                 | —            |
| C12             | 18pF Chip Capacitors                       | —                 | Murata       |
| PCB             | FR-4 ,0.030",ε <sub>r</sub> 4.5            | —                 | —            |

## TYPICAL CHARACTERISTICS

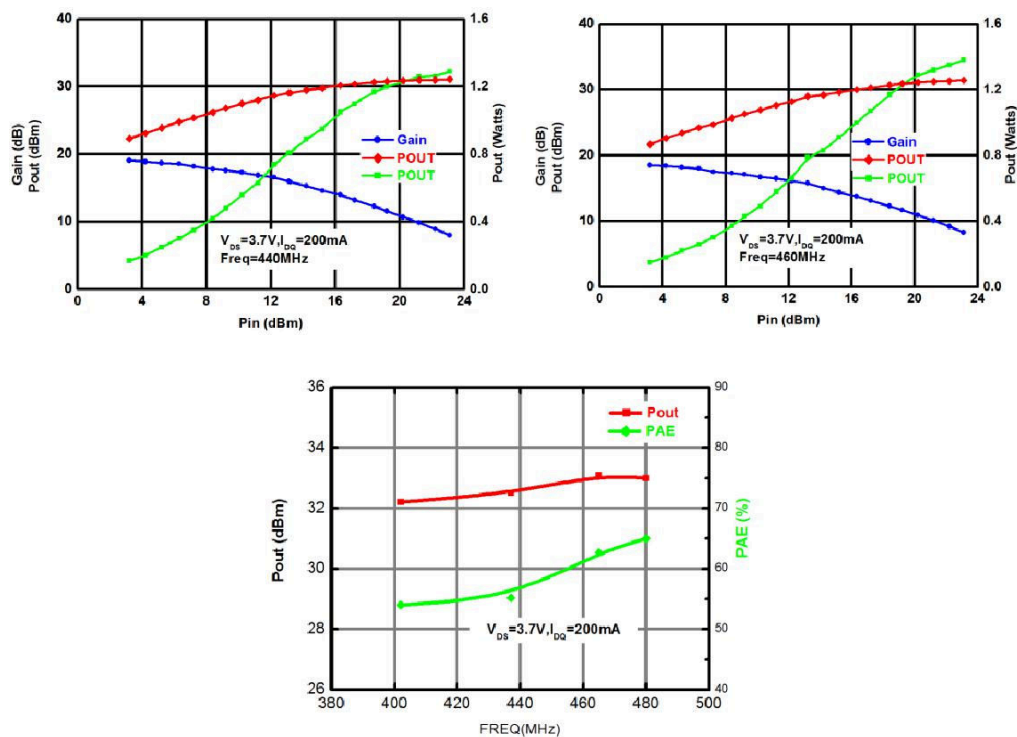
## 1、440MHz @Vds, Pout VS Vg



## 2、440MHz @Vgs, Pout Gain VS Pin



## 3、Freq@Vds, POUT, Pout Gain VS Pin

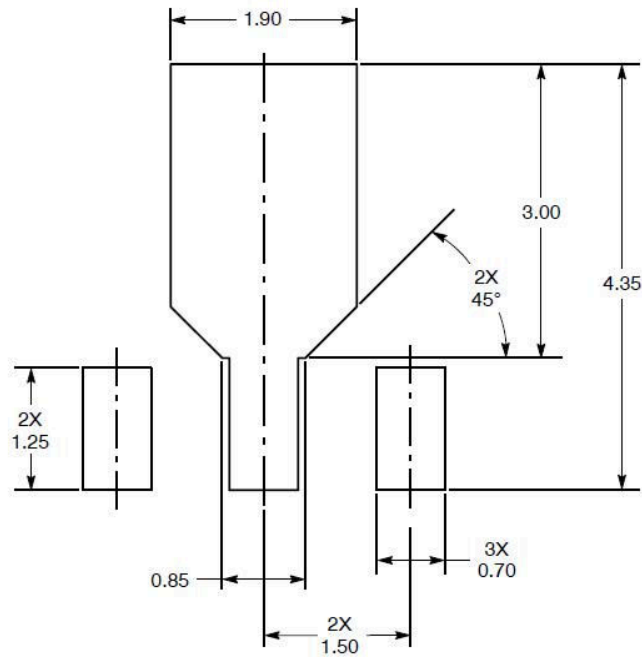


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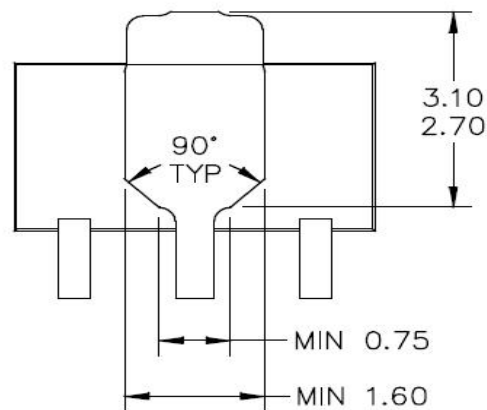
## RF Power Field Effect Transistor

### PACKAGE

Unit : mm



PCB Pad Layout for SOT- 89



Bottom View



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### REVISION HISTORY

The following table summarizes revisions to this document.

| Revision | Date     | Description                   |
|----------|----------|-------------------------------|
| 1.0      | May 2018 | Initial Release of Data Sheet |